



# DECLARATION FOR ORIGINAL U.S. PATENT APPLICATION

~~3~~

Attorney's Docket No: 68141675-200600

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: SYSTEM, METHOD AND ARTICLE OF MANUFACTURE FOR STORING AN INCOMING DATAGRAM IN SWITCH MATRIX IN A SWITCH FABRIC CHIPSET SYSTEM, the specification of which,

(check one)

1. ☐ is attached hereto.
2. ☒ was filed on September 25, 2000 as  
U.S. Application Serial No. 09/669,208  
and was amended on \_\_\_\_\_.
3. ☐ was filed on \_\_\_\_\_ as  
International PCT Application Serial No. \_\_\_\_\_  
and was amended on \_\_\_\_\_.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, CFR §1.56.

I hereby claim foreign priority benefits under Title 35, United States code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

## Prior Foreign Application(s)

## Priority Benefits Claimed?

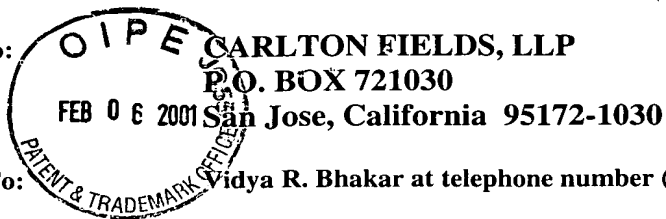
_____	_____	_____	__ Yes __ No
(Appl. No.)	(Country)	(Date Filed- Day/Month/Year)	
_____	_____	_____	__ Yes __ No
(Appl. No.)	(Country)	(Date Filed- Day/Month/Year)	
_____	_____	_____	__ Yes __ No
(Appl. No.)	(Country)	(Date Filed- Day/Month/Year)	

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this applications is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

## Prior U.S. Application(s)

<u>60/225,034</u>	<u>8/11/2000</u>	<u>Pending</u>
(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)
_____	_____	_____
(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)

Send Correspondence To:



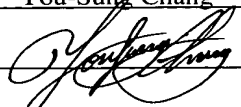
Direct Telephone Calls To: Vidya R. Bhakar at telephone number (408) 271-2300

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Typewritten Full Name of

Sole or First Inventor: You-Sung Chang

Citizenship: SOUTH KOREA

Inventor's signature: 

Date of Signature: January 30, 2001

Residence: (City) Taejon

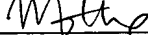
(State/Country) South Korea

Post Office Address: CHIPS Building, Third Floor, KAIST, 373-1 Kusung-Dong, Yusong-Gu, Taejon, 305-701, South Korea

Full Name of Second Joint

Inventor (if any): Jung-Bum Chun

Citizenship: SOUTH KOREA

Inventor's signature: 

Date of Signature: January 30, 2001

Residence: (City) Taejon

(State/Country) South Korea

Post Office Address: CHIPS Building, Third Floor, KAIST, 373-1 Kusung-Dong, Yusong-Gu, Taejon, 305-701, South Korea



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Y. Chang et al. )  
Application No. 09/669,208 ) Date: January 25, 2001  
Filing Date: September 25, 2000 )  
For: System, Method and Article of Manufacture for Storing )  
An Incoming Datagram in Switch Matrix in a Switch )  
Fabric Chipset System )

REVOCATION OF PRIOR POWERS OF ATTORNEY  
AND GRANT OF NEW POWER OF ATTORNEY

Assistant Commissioner for Patents  
Washington, D. C. 20231

Sir:

As assignee of record of the entire interest of the above-identified application (patent), all powers of attorney previously given are hereby revoked and the following attorneys and agents are hereby appointed to prosecute and transact all business in the U.S. Patent and Trademark Office connected therewith.

L. Keith Stephens (Reg. No. 32,632)  
Kevin J. Zilka (Reg. No. 41,429)  
Dominic M. Kotab (Reg. No. 42,762)  
Vidya R. Bhakar (Reg. No. 42,323)  
C. Douglas McDonald (Reg. No. 26,659)  
John C. Clark (Reg. No. 43,552)

Please send all correspondence for this application as follows:

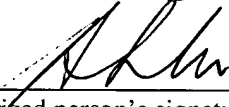
**Vidya R. Bhakar**  
CARLTON FIELDS  
P.O. Box 721030  
San Jose, CA 95172-1030

Please direct any calls to **Vidya R. Bhakar** at (408) 271-2300.

In accordance with 37 CFR 3.73, the assignee hereby certifies that the evidentiary documents with respect to its ownership have been reviewed and that, to the best of assignee's knowledge and belief, title is in the assignee seeking to take this action.

Co. Name: Paion Company, Ltd.  
Address: 500 Airport Blvd, Suite 333  
Burlingame, California 94101

Date 1.26.01

  
\_\_\_\_\_  
Authorized person's signature  
Name: Andy Lovas  
Title: VP Marketing and Sales